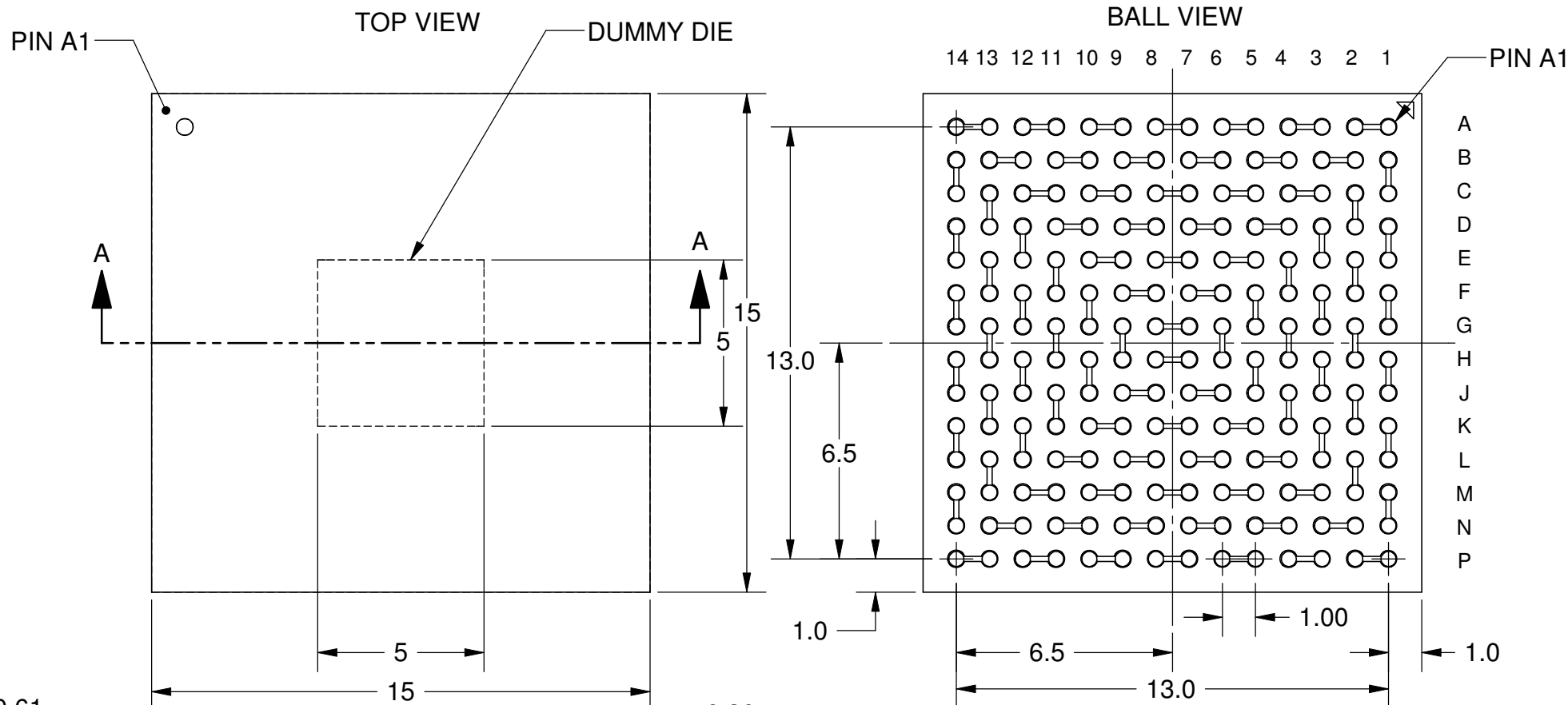




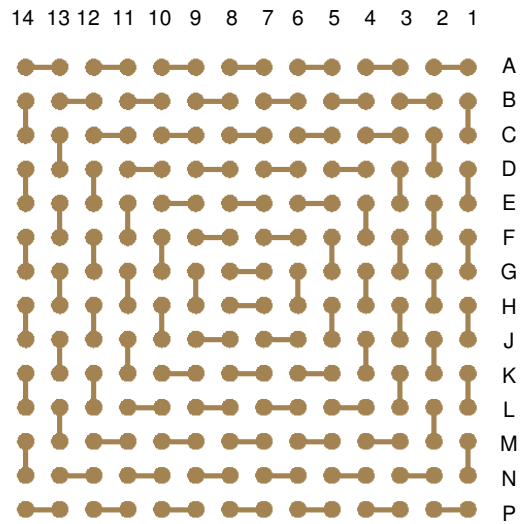
- Notes: (Unless Otherwise Specified).
- 1) ALL DIMENSIONS ARE IN MM.
 - 2) SOLDER BALL ALLOY: SEE PART NUMBER TABLE.
 - 3) BALL DIAMETER (BEFORE REFLOW): 0.45mm.
 - 4) SOLDER MASK DEFINED PAD OPENING: 0.36mm [14 MIL].
 - 5) PAD Cu DIAMETER: 0.508mm [20 MIL].
 - 6) SUBSTRATE MATERIAL: FR4 (ALTERNATE BT).
 - 7) DUMMY DIE IS OPTIONAL.
 - 8) DAISY CHAIN PATTERN (SEE PAGE 2).
 - 9) MSL-3 RECOMMEND BAKING 24 HOURS @ 125C TO REMOVE MOISTURE PRIOR TO SOLDERING TO PC BOARD.

PART NUMBER TABLE

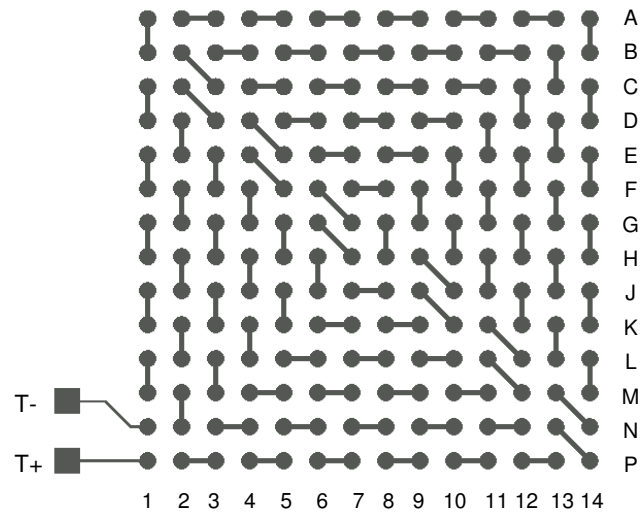
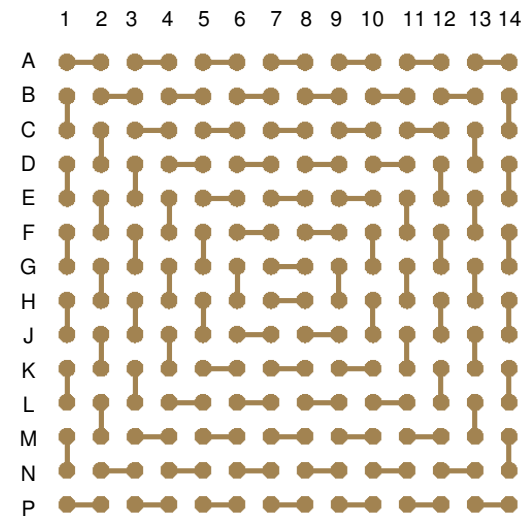
PART NUMBER	BALL ALLOY	BALL CODE	RoHS	Si DIE
BGA196T1.0C-DC149AD	Sn96.5/Ag3.0/Cu0.5	SAC305	YES	YES
BGA196T1.0C-DC149AD	Sn63/Pb37	Sn63	NO	YES

TOLERANCE UNLESS NOTED		APPROVALS		DATE		TopLine®					
X.X	+/- 0.3	DRAWN J. Hines		8/14/2012		TITLE BGA196T1.0-DC149AD DAISY CHAIN DUMMY					
X.XX	+/- 0.03										
X.XXX	+/- 0.003										
ANGLES +/- 0.5°		ENG									
ALL DIMENSIONS IN		MFG									
□ INCHES ☒ MILLIMETERS											
THIRD ANGLE PROJECTION		QA		SCALE 5.5:1		SIZE A	DRAWING NO. 511490		REV A		
		CUST									
		REVISED									
						DO NOT SCALE DRAWING				SHEET 1 OF 2	

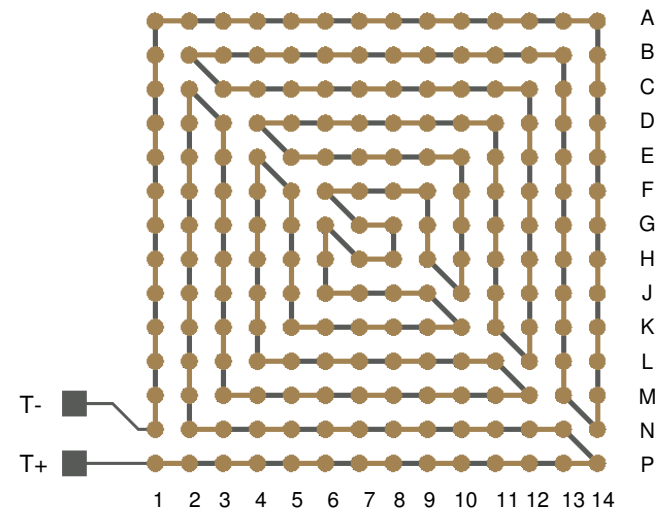
BALL VIEW



BOTTOM SIDE (TOP X-RAY VIEW)



TEST VEHICLE BOARD



AFTER MOUNTING

Notes:

- 1) PCB BOARD DIMENSIONS ARE PRESENTED ONLY AS A GUIDELINE. DESIGNERS SHOULD USE THEIR OWN EXPERIENCE WHEN DESIGNING PCB.
- 2) PCB Cu BALL PAD DIAMETER 0.508mm [20 MIL].
- 3) PCB DAISY CHAIN TRACING LINE WIDTH 0.152mm [6 MIL].
- 4) SMD (SOLDER MASK DEFINED) PAD OPENING 0.36mm [14 MIL].

TopLine

TITLE BGA196T1.0-DC149AD DAISY CHAIN DUMMY			
SCALE 4.5:1	SIZE A	DRAWING NO. 511490	REV A
DO NOT SCALE DRAWING		SHEET 2 OF 2	